

1:4 Differential LVDS Fanout Buffer with Selectable Clock Input

Features

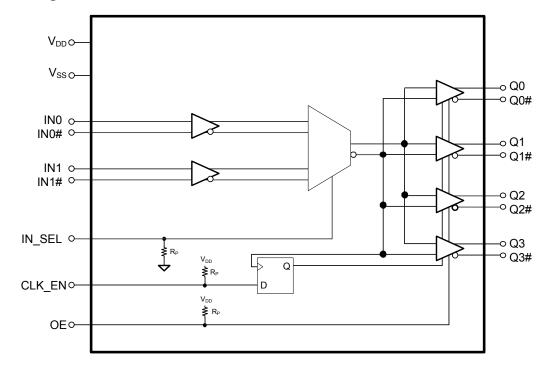
- Select one of two differential (LVPECL, LVDS, HCSL, or CML) input pairs to distribute to four LVDS output pairs
- Translates any single-ended input signal to 3.3 V LVDS levels with resistor bias on INx# input
- 30 ps maximum output-to-output skew
- 480 ps maximum propagation delay
- 0.11 ps maximum additive RMS phase jitter at 156.25 MHz (12 kHz to 20 MHz offset)
- Up to 1.5 GHz operation
- Output enable and synchronous clock enable functions
- 20-pin TSSOP
- 2.5 V or 3.3 V operating voltage [1]
- Commercial and industrial operating temperature range

Functional Description

The CY2DL1504 is an ultra-low noise, low-skew, low-propagation delay 1:4 differential LVDS fanout buffer targeted to meet the requirements of high-speed clock distribution applications. The CY2DL1504 can select between two separate differential (LVPECL, LVDS, HCSL, or CML) input clock pairs using the IN_SEL pin. The synchronous clock enable function ensures glitch-free output transitions during enable and disable periods. The output enable function allows the outputs to be asynchronously driven to a high-impedance state. The device has a fully differential internal architecture that is optimized to achieve low-additive jitter and low-skew at operating frequencies of up to 1.5 GHz.

For a complete list of related documentation, click here.

Logic Block Diagram



Note

^{1.} Input AC-coupling capacitors are required for voltage-translation applications.



Contents

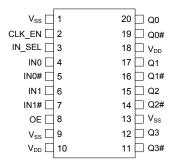
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Pinouts

Figure 1. 20-pin TSSOP pinout



Pin Definitions

| Pin No. | Pin Name | Pin Type | Description |
|----------------|-----------------|----------|--|
| 1, 9, 13 | V _{SS} | Power | Ground |
| 2 | CLK_EN | Input | Synchronous clock enable. LVCMOS/LVTTL; When CLK_EN = Low, Q(0:3) outputs are held low and Q(0:3)# outputs are held high |
| 3 | IN_SEL | Input | Input clock select pin. LVCMOS/LVTTL; When IN_SEL = Low, the IN0/IN0# differential input pair is active When IN_SEL = High, the IN1/IN1# differential input pair is active |
| 4 | IN0 | Input | Differential (LVPECL, HCSL, LVDS, or CML) input clock. Active when IN_SEL = Low |
| 5 | IN0# | Input | Differential (LVPECL, HCSL, LVDS, or CML) complementary input clock. Active when IN_SEL = Low |
| 6 | IN1 | Input | Differential (LVPECL, HCSL, LVDS, or CML) input clock. Active when IN_SEL = High |
| 7 | IN1# | Input | Differential (LVPECL, HCSL, LVDS, or CML) complementary input clock. Active when IN_SEL = High |
| 8 | OE | Input | Output enable. LVCMOS/LVTTL; When OE = Low, Q(0:3) and Q(0:3)# outputs are disabled (see I _{OZ}) |
| 10, 18 | V_{DD} | Power | Power supply |
| 11, 14, 16, 19 | Q(0:3)# | Output | LVDS complementary output clocks |
| 12, 15, 17, 20 | Q(0:3) | Output | LVDS output clocks |



Absolute Maximum Ratings

| Parameter | Description | Condition | Min | Max | Unit |
|---------------------------------|---|---------------------|--|---|------|
| V_{DD} | Supply voltage | Nonfunctional | -0.5 | 4.6 | V |
| V _{IN} ^[2] | Input voltage, relative to V _{SS} | Nonfunctional | -0.5 | Lesser of 4.0 or V _{DD} + 0.4 | V |
| V _{OUT} ^[2] | DC output or I/O voltage, relative to V _{SS} | Nonfunctional | -0.5 | Lesser of 4.0 or V _{DD} + 0.4 | V |
| T_S | Storage temperature | Nonfunctional | – 55 | 150 | °C |
| ESD _{HBM} | Electrostatic discharge (ESD) protection (Human body model) | JEDEC STD 22-A114-B | 2000 | _ | V |
| L _U | Latch up | | Meets or exceeds JEDEC Spec JESD78B IC latch up test | | D78B |
| UL-94 | Flammability rating | At 1/8 in. | V–0 | | |
| MSL | Moisture sensitivity level | | 3 | | |

Operating Conditions

| Parameter | Description | Condition | Min | Max | Unit |
|-----------------|-------------------------------|--|-------|-------|------|
| V_{DD} | Supply voltage | 2.5 V supply | 2.375 | 2.625 | V |
| | | 3.3 V supply | 3.135 | 3.465 | V |
| T _A | Ambient operating temperature | Commercial | 0 | 70 | °C |
| | | Industrial | -40 | 85 | °C |
| t _{PU} | Power ramp time | Power-up time for V _{DD} to reach minimum specified voltage. (Power ramp must be monotonic) | 0.05 | 500 | ms |

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Note
2. The voltage on any I/O pin cannot exceed the power pin during power-up. Power supply sequencing is not required.



DC Electrical Specifications

(V_{DD} = 3.3 V \pm 5% or 2.5 V \pm 5%; T_A = 0 °C to 70 °C (Commercial) or –40 °C to 85 °C (Industrial))

| Parameter | Description | Condition | Min | Max | Unit |
|---------------------------------------|---|--|-------------|-----------------------|------|
| I _{DD} | Operating supply current | All LVDS outputs terminated with a load of 100 $\Omega^{[3,4]}$ | - | 61 | mA |
| V _{IH1} | Input high voltage, differential input clocks, IN0, IN0#, IN1, and IN1# | | _ | V _{DD} + 0.3 | V |
| V _{IL1} | Input low voltage, differential input clocks, IN0, IN0#, IN1, and IN1# | | -0.3 | _ | V |
| V _{IH2} | Input high voltage, CLK_EN, IN_SEL, and OE | V _{DD} = 3.3 V | 2.0 | V _{DD} + 0.3 | V |
| V _{IL2} | Input low voltage, CLK_EN, IN_SEL, and OE | V _{DD} = 3.3 V | -0.3 | 0.8 | V |
| V _{IH3} | Input high voltage, CLK_EN, IN_SEL, and OE | V _{DD} = 2.5 V | 1.7 | V _{DD} + 0.3 | V |
| V _{IL3} | Input low voltage, CLK_EN, IN_SEL, and OE | V _{DD} = 2.5 V | -0.3 | 0.7 | V |
| V _{ID_LVDS} ^[5] | LVDS input differential amplitude | See Figure 3 on page 8 | 0.4 | 0.8 | V |
| V _{ID_LVPECL} ^[5] | LVPECL/CML/HCSL input differential amplitude | See Figure 3 on page 8 | 0.4 | 1.0 | V |
| V _{ICM} | Input common mode voltage | See Figure 3 on page 8 | 0.2 | V _{DD} – 0.2 | V |
| I _{IH} | Input high current, All inputs | Input = V _{DD} ^[6] | - | 150 | μΑ |
| I _{IL} | Input low current, All inputs | Input = V _{SS} ^[6] | -150 | - | μΑ |
| V _{PP} | LVDS differential output voltage peak to Peak, Single-ended | V_{DD} = 3.3 V or 2.5 V, R _{TERM} = 100 Ω between Q and Q# pairs [3, 7] | 250 | 470 | mV |
| V _{OCM} | LVDS differential output common mode voltage | V_{DD} = 3.3 V or 2.5 V, R _{TERM} = 100 Ω between Q and Q# pairs [3, 7] | 1.125 | 1.375 | V |
| ΔV_{OCM} | Change in V _{OCM} between complementary output states | V_{DD} = 3.3 V or 2.5 V, R_{TERM} = 100 Ω between Q and Q# pairs ^[3, 7] | - | 50 | mV |
| I _{OZ} | Output leakage current | OE = V _{SS} , V _{OUT} = 0.75 V–1.75 V | – 15 | 15 | μΑ |
| R _P | Internal pull-up/pull-down resistance, LVCMOS logic inputs | CLK_EN has pull-up only IN_SEL has pull-down only OE has pull-up only | 60 | 165 | kΩ |
| C _{IN} | Input capacitance | Measured at 10 MHz; per pin | - | 3 | pF |

Thermal Resistance

| Parameter [8] | Description | Test Conditions | 20-pin TSSOP | Unit |
|---------------|---------------------------------------|---|--------------|------|
| - 3/1 | (junction to ambient) | Test conditions follow standard test methods and procedures for measuring thermal impedance, in | | °C/W |
| θ_{JC} | Thermal resistance (junction to case) | accordance with EIA/JESD51. | 16 | °C/W |

Notes

- Notes

 Refer to Figure 2 on page 8.

 IDD includes current that is dissipated externally in the output termination resistors.

 VID minimum of 400 mV is required to meet all output AC Electrical Specifications. The device is functional with VID minimum of greater than 200 mV.

 Positive current flows into the input pin, negative current flows out of the input pin.

 Refer to Figure 4 on page 8.

 These parameters are guaranteed by design and are not tested.

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AC Electrical Specifications

(V_{DD} = 3.3 V \pm 5% or 2.5 V \pm 5%; T_A = 0 °C to 70 °C (Commercial) or –40 °C to 85 °C (Industrial))

| Parameter | Description | Condition | Min | Тур | Max | Unit |
|------------------------------------|--|---|-----|-----|-------------|------------|
| F _{IN} | Input frequency | Differential Input | DC | _ | 1.5 | GHz |
| | | Single ended input [9] | DC | _ | 250 | MHz |
| F _{OUT} | Output frequency | F _{OUT} = F _{IN,} Differential Input | DC | _ | 1.5 | GHz |
| | | F _{OUT} = F _{IN,} Single ended input ^[9] | DC | _ | 250 | MHz |
| t _{PD} ^[10] | Propagation delay differential input pair to differential output pair | Input rise/fall time < 1.5 ns (20% to 80%) | - | _ | 480 | ps |
| t _{ODC} ^[11] | Output duty cycle | Diff input at 50% duty cycle Frequency range up to 1 GHz | 48 | - | 52 | % |
| | | 50% duty cycle at input, Frequency range up to 250MHz, Single ended input ^[9] | 45 | _ | 55 | % |
| t _{SK1} ^[12] | Output-to-output skew | Any output to any output, with same load conditions at DUT | - | - | 30 | ps |
| t _{SK1 D} ^[12] | Device-to-device output skew | Any output to any output between two or more devices. Devices must have the same input and have the same output load. | - | _ | 150 | ps |
| PN _{ADD} | Additive RMS phase noise 156.25 MHz Input | Offset = 1 kHz | - | - | -120 | dBc/ Hz |
| | Rise/fall time < 150 ps (20% to 80%) V _{ID} > 400 mV or | Offset = 10 kHz | - | - | -135 | dBc/ Hz |
| | $V_{1D} > 400 \text{ mV} \text{ or}$ Input Swing = 3.0 $V^{[9]}$ | Offset = 100 kHz | - | - | -135 | dBc/ Hz |
| | | Offset = 1 MHz | - | - | -150 | dBc/ Hz |
| | | Offset = 10 MHz | - | _ | -154 | dBc/ Hz |
| | | Offset = 20 MHz | - | _ | –155 | dBc/ Hz |

^{9.} Refer to Application Information on page 10.
10. Refer to Figure 5 on page 8.
11. Refer to Figure 6 on page 8.
12. Refer to Figure 7 on page 9.



AC Electrical Specifications (continued)

(V_{DD} = 3.3 V \pm 5% or 2.5 V \pm 5%; T_A = 0 °C to 70 °C (Commercial) or –40 °C to 85 °C (Industrial))

| Parameter | Description | Condition | Min | Тур | Max | Unit |
|---|--|--|-----|-----|------|------|
| t _{JIT} [13] | Additive RMS phase jitter (Random) | 156.25 MHz, 12 kHz to 20 MHz offset; input rise/fall time < 150 ps (20% to 80%), V _{ID} > 400 mV | _ | - | 0.11 | ps |
| | | 156.25 MHz Sinewave, 12 kHz to 20 MHz offset, input rise/fall time < 150 ps (20% to 80%), Input Swing = 3.0 V [14] | _ | - | 0.11 | ps |
| t _R , t _F ^[15] | Output rise/fall time, single-ended | 50% duty cycle at input, 20% to 80% of full swing (V _{OL} to V _{OH}) Input rise/fall time < 1.5 ns (20% to 80%) Measured at 1 GHz. | - | - | 300 | ps |
| t _{SOD} | Time from clock edge to outputs disabled | Synchronous clock enable (CLK_EN) switched low | - | - | 700 | ps |
| t _{SOE} | Time from clock edge to outputs enabled | Synchronous clock enable (CLK_EN) switched high | _ | - | 700 | ps |

Notes
13. Refer to Figure 8 on page 9.
14. Refer to Application Information on page 10.
15. Refer to Figure 9 on page 9.



Switching Waveforms

Figure 2. LVDS Output Termination

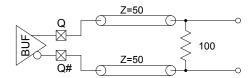


Figure 3. Input Differential and Common Mode Voltages

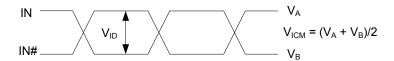


Figure 4. Output Differential and Common Mode Voltages

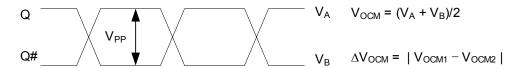


Figure 5. Input to Any Output Pair Propagation Delay

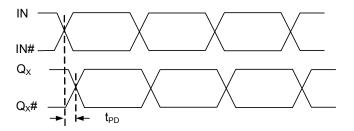
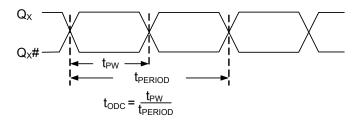


Figure 6. Output Duty Cycle





Switching Waveforms (continued)

Figure 7. Output-to-output and Device-to-device Skew

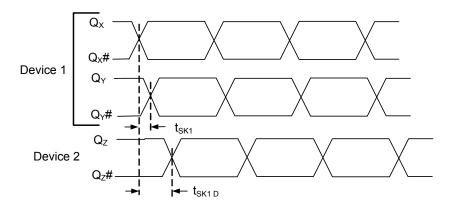
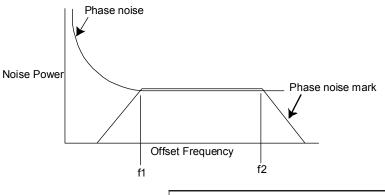
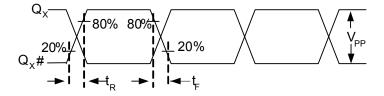


Figure 8. RMS Phase Jitter



 $RMS\ Jitter\ \infty\ \sqrt{\mbox{Area Under the Masked Phase Noise Plot}}$

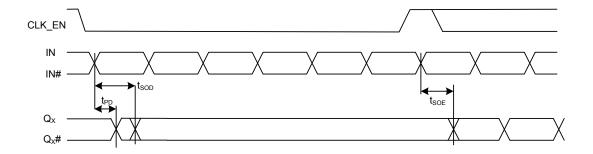
Figure 9. Output Rise/Fall Time





Switching Waveforms (continued)

Figure 10. Synchronous Clock Enable Timing



Application Information

CY2DL1504 can be used with a single ended CMOS input by biasing the Complementary Input Clock (INx#). "True" input pins (INx) of differential input pair can be fed with a single ended CMOS input signal. The "complementary" input pin (INx#) of the same differential input pair can be biased with Vref.

Figure 11 shows the schematic which can be used to give single ended CMOS input to the CY2DL1504.

The reference voltage Vref = VDD/2 is generated by the bias resistors R1, R2 and capacitor C0. This bias circuit should be located as close as possible to the input pin. The ratio of R1 and R2 might need to be adjusted to position the Vref in the center of the input voltage swing. For example, if the input clock swing is 2.5 V and VDD = 3.3 V, Vref should be 1.25 V and R2/R1 = 0.609.

Single Ended Clock Input

Vref

C0
0.1 u

R2
1K

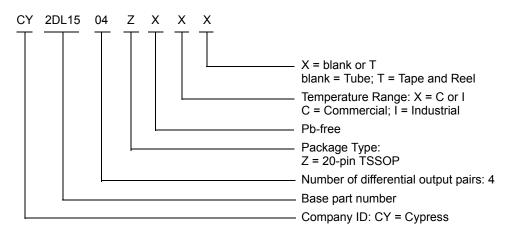
Figure 11. Single ended CMOS input given to the CY2DL1504



Ordering Information

| Part Number | Туре | Production Flow |
|---------------|--|---------------------------|
| Pb-free | | |
| CY2DL1504ZXC | 20-pin TSSOP | Commercial, 0 °C to 70 °C |
| CY2DL1504ZXCT | 20-pin TSSOP Commercial, 0 °C to 70 °C | |
| CY2DL1504ZXI | 20-pin TSSOP Industrial, –40 °C to 85 °C | |
| CY2DL1504ZXIT | 20-pin TSSOP Industrial, -40 °C to 85 °C | |

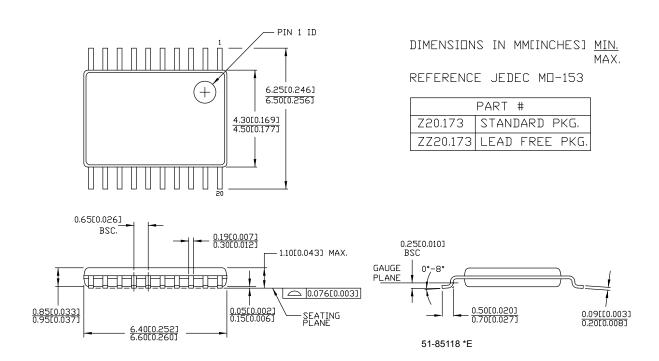
Ordering Code Definitions





Package Diagram

Figure 12. 20-pin TSSOP (4.40 mm Body) Z20.173/ZZ20.173 Package Outline, 51-85118





Acronyms

| Acronym | Description |
|---------|---|
| ESD | electrostatic discharge |
| HBM | human body model |
| HCSL | high-speed current steering logic |
| JEDEC | joint electron devices engineering council |
| LVDS | low-voltage differential signal |
| LVCMOS | low-voltage complementary metal oxide semiconductor |
| LVPECL | low-voltage positive emitter-coupled logic |
| LVTTL | low-voltage transistor-transistor logic |
| OE | output enable |
| RMS | root mean square |
| TSSOP | thin shrunk small outline package |

Document Conventions

Units of Measure

| Symbol | Unit of Measure |
|--------|----------------------------------|
| °C | degree Celsius |
| dBc | decibels relative to the carrier |
| GHz | gigahertz |
| Hz | hertz |
| kΩ | kilohm |
| MHz | megahertz |
| μΑ | microampere |
| μF | microfarad |
| μs | microsecond |
| mA | milliampere |
| ms | millisecond |
| mV | millivolt |
| ns | nanosecond |
| Ω | ohm |
| pF | picofarad |
| ps | picosecond |
| V | volt |
| W | watt |



Document History Page

| Document Title: CY2DL1504, 1:4 Differential LVDS Fanout Buffer with Selectable Clock Input Document Number: 001-56312 | | | | | | | |
|---|---------|--------------------|--------------------|--|--|--|--|
| Revision | ECN | Orig. of Change | Submission Date | Description of Change | | | |
| ** | 2782891 | CXQ | 10/09/09 | New data sheet. | | | |
| *A | 2838613 | CXQ | 01/05/2010 | Changed status from Advance to Preliminary. Changed from 0.34 ps to 0.25 ps maximum additive jitter in "Features" on page 1 and in t_{JIT} in the AC Electrical Specs table on page 5. Added t_{PU} spec to the Operating Conditions table on page 3. Changed max I_{DD} spec in the DC Electrical Specs table on page 4 from 60 m/s to 61 mA. Removed V_{OD} and ΔV_{OD} specs from the DC Electrical Specs table on page 4 Changed I_{OZ} in the DC Electrical Specs table on page 4 from min of -10 uA to -15 uA and from max of 10 uA to 15 uA. Added R_P spec in the DC Electrical Specs table on page 4. Min = 60 k Ω , Max = 140 k Ω . Added a measurement definition for C_{IN} in the DC Electrical Specs table on page 4. Added V_{PP} and ΔV_{PP} specs to the AC Electrical Specs table on page 5. V_{PP} min = 250 mV and max = 470 mV; ΔV_{PP} max = 50 mV. Changed letter case and some names of all the timing parameters in the AC Electrical Specs table on page 5. Added condition to V_{RP} and V_{RP} specs in the AC Electrical specs table on page 5. Added condition to V_{RP} and V_{RP} specs in the AC Electrical specs table on page 5 that input rise/fall time must be less than 1.5 ns (20% to 80%). Changed letter case and some names of all the timing parameters in Figures 4, 5, 6, 7 and 9, to be consistent with EROS. Updated Figure 4 with definition for V_{PP} and ΔV_{PP} | | | |
| *B | 3010332 | CXQ | 08/18/2010 | Changed from 0.25 ps to 0.11 ps maximum additive jitter in "Features" on page 1 and in t_{JIT} in the AC Electrical Specs table on page 5. Added "Functional equivalent to ICS8543i" to the "Features" section. Changed pin 13 in Figure 1 and Table 1 from V_{DD} to V_{SS} . Changed pin 8 description in Table 1 from "high impedance" to "disabled". Added note 6 to describe I_{IH} and I_{IL} specs. Removed reference to data distribution from "Functional Description". Changed R_P for diff inputs from 100 $k\Omega$ to 150 $k\Omega$ in the Logic Block Diagran and from 60 $k\Omega$ min / 140 $k\Omega$ max to 90 $k\Omega$ min / 210 $k\Omega$ max in the DC Electrical Specs table. Split V_{ID} into separate specs in DC Electrical Specs table: 0.4 V min and 0.8 V max for LVDS, 0.4 V min and 1.0 V max for LVPECL. Updated phase noise specs for 1 k/10 k/100 k/1 M/10 M/20 MHz offset to -120/-130/-135/-150/-150/-150dBc/Hz, respectively, in the AC Electrical Spectable. Added "Frequency range up to 1 GHz" condition to t_{ODC} spec. Changed t_{OD} in the AC Electrical Specs table from 3 ns max to 5 ns max. Added Acronyms and Ordering Code Definition. | | | |



Document History Page (continued)

| Document Title: CY2DL1504, 1:4 Differential LVDS Fanout Buffer with Selectable Clock Input Document Number: 001-56312 | | | | | | |
|---|---------|--------------------|--------------------|---|--|--|
| Revision | ECN | Orig. of Change | Submission Date | Description of Change | | |
| *C | 3090644 | CXQ | 11/19/2010 | Changed V_{IN} and V_{OUT} specs from 4.0V to "lesser of 4.0 or V_{DD} + 0.4" Removed 200mA min LU spec, replaced with "Meets or exceeds JEDEC Spe JESD78B IC Latchup Test" Added " V_{OUT} = 0.75V - 1.75V" to I_{OZ} comments. Moved V_{PP} from AC spec table to DC spec table, removed ΔV_{PP} Removed R_P spec for differential input clock pins IN_X and IN_X #. Changed C_{IN} condition to "Measured at 10 MHz". Changed PN_{ADD} specs for 10kHz, 10MHz, and 20MHz offsets. Added "Measured at 1 GHz" to I_R , I_R spec condition. Removed specs I_S , I_H , I_{OD} , and I_{OE} from AC spec table. Removed ΔV_{PP} reference from Figure 4. | | |
| *D | 3135189 | CXQ | 01/12/2011 | Changed status from Preliminary to Final. Removed "Functional equivalent" bullet on page 1. Added "(see I _{OZ})" note to pin 8 description in Pin Definitions. Fixed typo and removed resistors from IN _X /IN _X # in Logic Block Diagram. Added Figure 10 to describe T _{SOE} and T _{SOD} . | | |
| *E | 3090938 | CXQ | 02/25/11 | Post to external web. | | |
| *F | 3208968 | CXQ | 03/29/2011 | Changed R_P max from 140 $k\Omega$ to 165 $k\Omega$ and updated R_P in Logic Block Diagram. | | |
| *G | 3308039 | CXQ | 07/11/2011 | Updated supported differential input clock types to include CML in Features Functional Description, Pin Definitions, and DC specs table sections. | | |
| *H | 3395868 | PURU | 10/05/11 | Updated supported differential input clock types to include HCSL in Features Pinouts, and DC Electrical Specifications table. Changed Min value of $V_{\rm ICM}$. | | |
| * | 3892255 | PURU | 02/01/2013 | Updated Features (Added "Translates any single-ended input signal to 3.3 LVPECL levels with resistor bias on INx# input"). Updated AC Electrical Specifications: Added Note 9 and Note 14. Added F $_{\rm IN}$ parameter values for "Single Ended Input" condition (Minimum value = DC, Maximum value = 250 MHz). Added F $_{\rm OUT}$ parameter values for "Single Ended Input" condition (Minimum value = DC, Maximum value = 250 MHz). Added t $_{\rm ODC}$ parameter values for "Single Ended Input" condition (Minimum value = 45%, Maximum value = 55%). Updated Description of PN $_{\rm ADD}$ parameter (Replaced "Additive RMS phasinoise, 156.25-MHz input, Rise/fall time < 150 ps (20% to 80%), V $_{\rm ID}$ > 400 mV with "Additive RMS phase noise, 156.25-MHz input, Rise/fall time < 150 ps (20% to 80%), V $_{\rm ID}$ > 400 mV or Input Swing = 3.0 V $^{(9)}$ "). Added t $_{\rm JIT}$ parameter values for the Condition "156.25 MHz Sinewave, 12 kHz to 20 MHz offset, input rise/fall time < 150 ps (20% to 80%), Input Swing = 3.0 V $^{(14)}$ " (Maximum value = 0.11 ps). Added Application Information. Updated to new template. | | |
| *J | 4587249 | PURU | 12/04/2014 | Updated Functional Description: Added "For a complete list of related documentation, click here." at the end. Updated Package Diagram: spec 51-85118 – Changed revision from *D to *E. | | |
| *K | 5267558 | PSR | 05/13/2016 | Added Thermal Resistance. Updated to new template. | | |
| *L | 5962077 | AESATMP8 | 11/09/2017 | Updated logo and Copyright. | | |



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